## **ADNS-7550**

## Integrated molded lead-frame DIP Sensor



# **Data Sheet**





## Theory of Operation

The ADNS-7550 integrated molded lead-frame DIP sensor comprises of sensor and VCSEL in a single package.

The advanced class of VCSEL was engineered by Avago Technologies to provide a laser diode with a single longitudinal and a single transverse mode. In contrast to most oxide-based single-mode VCSEL, this class of Avago VCSEL remains within single mode operation over a wide range of output power. It has significantly lower power consumption than a LED. It is an excellent choice for optical navigation applications.

The sensor is based on LaserStream<sup>™</sup> technology, which measures changes in position by optically acquiring sequential surface images (frames) and mathematically determining the direction and magnitude of movement. It contains an Image Acquisition System (IAS), a Digital Signal Processor (DSP), and a four wire serial port. The IAS acquires microscopic surface images via the lens and illumination system. These images are processed by the DSP to determine the direction and distance of motion. The DSP calculates the  $\Delta x$  and  $\Delta y$  relative displacement values. An external microcontroller reads the  $\Delta x$  and  $\Delta y$  information from the sensor serial port. The microcontroller then translates the data into PS2, USB, or RF signals before sending them to the host PC or game console.

ADNS-7550 entry level laser sensor mouse bundles include:

Bundle Part		
Number	Part Number	Description
ADNB-7552	ADNS-7550	Integrated molded lead-frame DIP sensor
	ADNS-6150	Small form factor lens
ADNB-7552-TL	ADNS-7550	Integrated molded lead-frame DIP sensor
	ADNS-6160-001	Small form factor trim lens
ADNB-7552-WTL	ADNS-7550	Integrated molded lead-frame DIP sensor
	ADNS-6170-002	Wide trim lens



### **Features**

- Wide operating voltage: 4.0V-5.25V.
- Small form factor, integrated molded lead-frame chipon-board package
- LaserStream<sup>™</sup> technology
- High speed motion detection up to 30 ips and 8G
- Enhanced SmartSpeed self-adjusting frame rate for optimum performance
- Motion detect pin output
- 12-bits motion data registers.
- Internal oscillator no clock input needed.
- Selectable 400, 800, 1200, 1600 cpi resolution.
- Four wire serial port
- Minimal number of passive components
- Laser fault detect circuitry on-chip for Eye Safety Compliance
- Advanced Technology VCSEL chip
- Single Mode Lasing operation
- 832-865 nm wavelength

## **Applications**

- Laser Mice
- Optical trackballs
- Integrated molded lead-frame input devices

## Pinout of ADNS-7550 Optical Mouse Sensor

Pin	Name	Description
1	+VCSEL	Positive Terminal of VCSEL
2	LASER_NEN	LASER Enable (Active LOW)
3	NCS	Chip select (active low input)
4	MISO	Serial data output (Master In/Slave Out)
5	SCLK	Serial clock input
6	MOSI	Serial data input (Master Out/Slave In)
7	MOTION	Motion Detect (active low output)
8	XYLASER	XYLASER
9	VDD5	5V Input
10	NC	No Connection
11	GND	Ground
12	RefB	3V output
13	RefA	1.8V regulator output
14	DGND	Digital Ground
15	VDDIO	10 Voltage input (1.65~3.6V)
16	-VCSEL	Negative Terminal of VCSEL

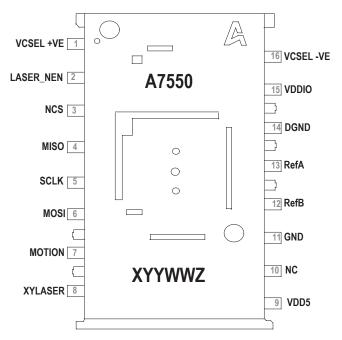
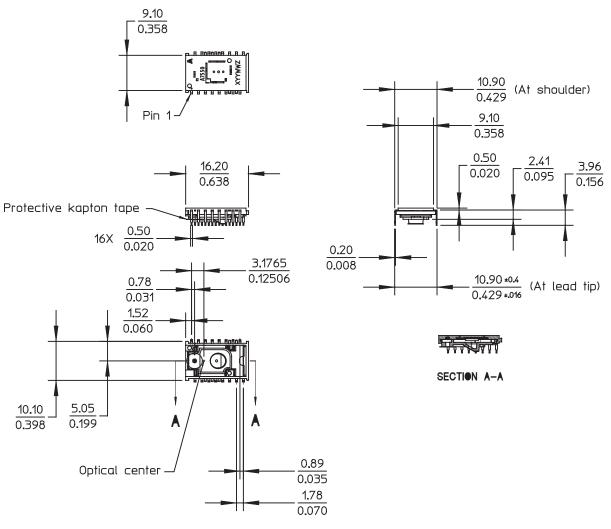


Figure 1. Device pin-out for ADNS-7550



## Notes:

- 1. Dimensions in millimeters (inches).
- 2. Dimensional tolerance: ±0.1 mm.
- 3. Coplanarity of lead: 0.1 mm.
- 4. Lead pitch tolerance: ±0.15 mm.
- 5. Cumulative pitch tolerance: ±0.15 mm.
- 6. Angular tolerance: ±3.0°.
- 7. Maximum flash: + 0.2 mm.
- 8. Chamfer (25°  $\times$  2) on the taper side of the lead.

Figure 2. Package outline drawing

**CAUTION**: It is advised that normal static precautions be taken in handling and assembly of this component to prevent damage and/or degradation which may be induced by ESD

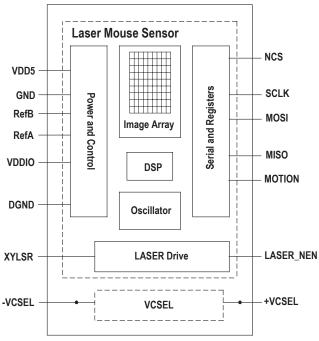


Figure 3. Block diagram of ADNS-7550 integrated molded lead-frame DIP sensor

## **Regulatory Requirements**

- Passes FCC B and worldwide analogous emission limits when assembled into a mouse with shielded cable and following Avago recommendations.
- Passes IEC-1000-4-3 radiated susceptibility level when assembled into a mouse with shielded cable and following Avago recommendations.
- Passes EN61000-4-4/IEC801-4 EFT tests when assembled into a mouse with shielded cable and following Avago recommendations.
- Provides sufficient ESD creepage/clearance distance to avoid discharge up to 15kV when assembled into a mouse according to usage instructions above.

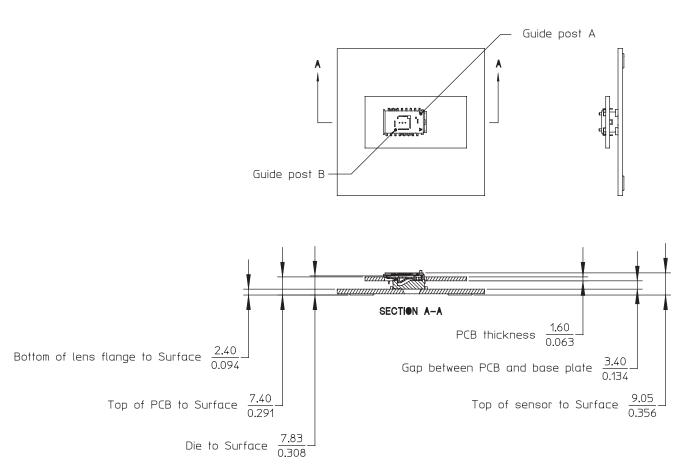


Figure 4. 2D Assembly drawing of ADNS-7550 sensor coupled with the ADNS-6150 lens, PCB and base plate (top and cross-sectional view)

## **Assembly Recommendation**

- 1. Insert the integrated molded lead-frame DIP sensor and all other electrical components into the application PCB.
- Wave-solder the entire assembly in a no-wash solder process utilizing a solder fixture. The solder fixture is needed to protect the sensor during the solder process. The fixture should be designed to expose the sensor leads to solder while shielding the optical aperture from direct solder contact.
- 3. Place the lens onto the base plate. Care must be taken to avoid contamination on the optical surfaces.
- 4. Remove the protective kapton tapes from the optical aperture of the sensor and VCSEL respectively. Care must be taken to keep contaminants from entering the aperture.
- 5. Insert the PCB assembly over the lens onto the base plate. The sensor package should self-align to the lens. The optical position reference for the PCB is set by the base plate and lens. The alignment guide post of the lens locks the lens and integrated molded lead-frame DIP sensor together. Note that the PCB motion due to button presses must be minimized to maintain optical alignment.
- 6. Optional: The lens can be permanently locked to the sensor package by melting the lens' guide posts over the sensor with heat staking process.

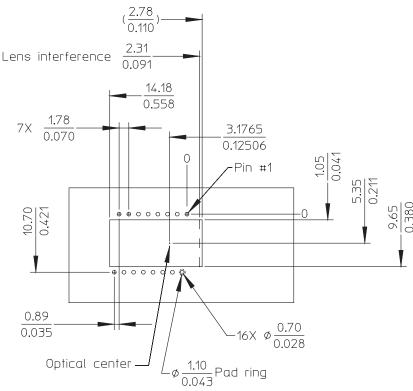
- 7. Tune the laser output power from the VCSEL to meet the Eye Safe Class I Standard as detailed in the LASER Power Adjustment Procedure.
- 8. Install the mouse top case. There must be a feature in the top case (or other area) to press down onto the sensor to ensure the sensor and lenses are interlocked to the correct vertical height.

## Design considerations for improving ESD Performance

For improved electrostatic discharge performance, typical creepage and clearance distance are shown in the table below. Assumption: base plate construction as per the Avago supplied IGES file and ADNS-6150, ADNS-6160-001 or ADNS-6170-002 lens:

Lens	ADNS-6150	ADNS-6160-001	ADNS-6170-002
Creepage	12.0 mm	16 mm	22 mm
Clearance	2.1 mm	1.28 mm	1.28 mm

Note that the lens material is polycarbonate and therefore, cyanoacrylate based adhesives or other adhesives that may damage the lens should NOT be used.



Dimensions in mm / inches

Figure 5. Recommended PCB mechanical cutouts and spacing

# **Application Circuit**

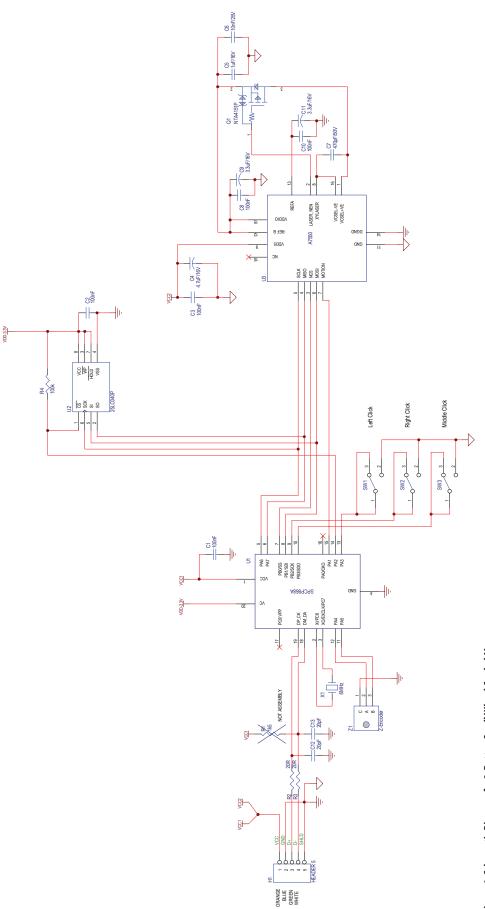


Figure 6. Schematic Diagram for 3-Button Scroll Wheel Corded Mouse

- Notes
  1. The supply and ground paths should be laid out using a star methodology.
  2. Level shifting is required to interface a 5V micro-controller to the ADNS-7550. If a 3V micro-controller is used, the 74VHC125 component shown may be omitted

## **LASER Drive Mode**

The laser is driven in pulsed mode during normal operation. A calibration mode is provided which drives the laser in continuous (CW) operation.

## **Eye Safety**

The ADNS-7550 integrated molded lead-frame DIP sensor and the associated components in the schematic of Figure 5 are intended to comply with Class 1 Eye Safety Requirements of IEC 60825-1. Avago Technologies suggests that manufacturers perform testing to verify eye safety on each mouse. It is also recommended to review possible single fault mechanisms beyond those described below in the section "Single Fault Detection". Under normal conditions, the sensor generates the drive current for the VCSEL.

In order to stay below the Class 1 power requirements, LASER\_CTRL0 (register 0x1a), LASER\_CTRL1 (register 0x1f), LSRPWR\_CFG0 (register 0x1c) and LSRPWR\_CFG1 (register 0x1d) must be programmed to appropriate values. The ADNS-7550 integrated molded lead-frame DIP sensor which comprised of the sensor and VCSEL; is designed to maintain the output beam power within Class 1 requirements over components manufacturing tolerances and the recommended temperature range when adjusted per the procedure below and implemented as shown in the recommended application circuit of Figure 6. For more information, please refer to Eye Safety Application Note AN 5361.

## **LASER Power Adjustment Procedure**

- 1. The ambient temperature should be 25C +/- 5C.
- 2. Set  $V_{DD5}$  to its permanent value.
- 3. Set the Range bits (bit 7 and 6 of register 0x1f) to b'01.
- 4. Set the Range\_C1 and Range\_C0 complement bits (bit 7 and 6 of register 0x1f) to b'10.
- 5. Enable the Calibration mode by writing to bits [3, 2, 1] of register 0x1A so the laser will be driven with 100% duty cycle.
- 6. Write the Calibration mode complement bits to register 0x1f.

- 7. Set the laser current to the minimum value by writing 0x00 to register 0x1c, and the complementary value 0xFF to register 0x1d.
- 8. Program registers 0x1c and 0x1d with increasing values to achieve an output power as close to 506uW as possible without exceeding it. If this power is obtained, the calibration is complete, skip to step 13.
- 9. If it was not possible to achieve the power target, set the laser current to the minimum value by writing 0x00 to register 0x1c, and the complementary value 0xff to register 0x1d.
- 10. Set the Range and Range\_C bits in registers 0x1a and 0x1f, respectively, to choose to the higher laser current range.
- 11. Program registers 0x1c and 0x1d with increasing values to achieve an output power as close to 506uW as possible without exceeding it.
- 12. Save the value of registers 0x1a, 0x1c, 0x1d, and 0x1f in non-volatile memory in the mouse. These registers must be restored to these values every time the ADNS-7550 is reset.
- Reset the mouse, reload the register values from non-volatile memory, enable Calibration mode, and measure the laser power to verify that the calibration is correct.

Good engineering practices such as regular power meter calibration, random quality assurance retest of calibrated mice, etc. should be used to guarantee performance, reliability and safety for the product design.

## **LASER Output Power**

The laser beam output power as measured at the navigation surface plane is specified below. The following conditions apply:

- 1. The system is adjusted according to the above procedure.
- 2. The system is operated within the recommended operating temperature range.
- No allowance for optical power meter accuracy is assumed.

## Disabling the LASER

LASER\_NEN is connected to the gate of a P-channel MOSFET transistor which when ON connects RefB to the LASER. In normal operation, LASER\_NEN is low. In the case of a fault condition (ground or RefB at XYLASER), LASER\_NEN goes high to turn the transistor off and disconnect RefB from the LASER.

## **Single Fault Detection**

ADNS-7550 is able to detect a short circuit or fault condition at the XYLASER pin, which could lead to excessive laser power output. A path to ground on this

pin will trigger the fault detection circuit, which will turn off the laser drive current source and set the LASER\_NEN output high. When used in combination with external components as shown in the block diagram below, the system will prevent excess laser power for a resistive path to ground at XYLASER by shutting off the laser. In addition to the ground path fault detection described above, the fault detection circuit is continuously checking for proper operation by internally generating a path to ground with the laser turned off via LASER\_NEN. If the XYLASER pin is shorted to VDD5/RefA/RefB, this test will fail and will be reported as a fault.

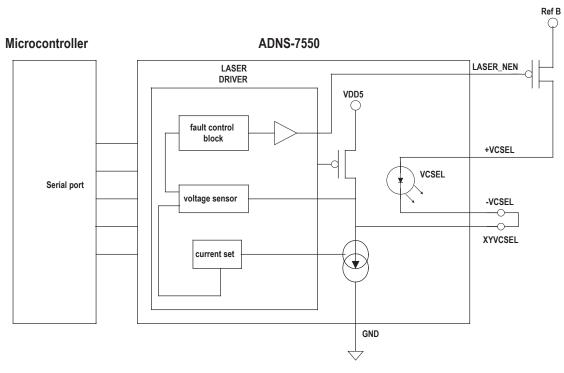


Figure 7. Single Fault Detection and Eye-safety Feature Block Diagram

## **Absolute Maximum Ratings**

Parameter	Symbol	Minimum	Maximum	Units	Notes
Storage Temperature	Ts	-40	85	٥	
Lead-Free Solder Temp			255	٥(	For 10 seconds, 1.8mm below seating plane. See soldering reflow profile in Figure 10.
Supply Voltage	$V_{DD5}$	-0.5	5.5	V	
ESD (Human body model MIL 883 Method 3015)			2	kV	All Pins
Input Voltage	V <sub>IN</sub>	-0.5	V <sub>DDIO</sub> + 0.5	٧	All I/O Pins
Latchup Current	I <sub>OUT</sub>		20	mA	All Pins
VCSEL DC Forward Current	I <sub>F</sub>		12	mA	
VCSEL Peak Pulsing Current	lр		19	mA	Duration = 100ms, 10% duty cycle
VCSEL Power Dissipation	Р		24	mW	
VCSEL Reverse Voltage	$V_R$		5	V	Ι = 10μΑ
VCSEL Junction Temperature	Tj		150	٥	For lead solder temperature above TJ, it is advisable to refer to soldering reflow profile in Figure 9.

## Comments:

- 1. Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are the stress ratings only and functional operation of the device at these or any other condition beyond those indicated for extended period of time may affect device reliability.
- 2. The maximum ratings do not reflect eye-safe operation. Eye safe operating conditions are listed in the power adjustment procedure section.
- 3. The inherent design of this component causes it to be sensitive to electrostatic discharge. The ESD threshold is listed above. To prevent ESD-induced damage, take adequate ESD precautions when handling this product.

## **Recommended Operating Conditions**

Parameter	Symbol	Minimum	Typical	Maximum	Units	Notes
Operating Temperature	T <sub>A</sub>	0		40	°C	
Power supply voltage	$V_{DD5}$	4.0	5.0	5.25	Volts	Including noise.
Power supply rise time	V <sub>RT5</sub>	1		100	ms	0 to 5.0V
Supply noise (Sinusoidal)	V <sub>NA</sub>			100	mVp-p	10kHz-50MHz
Serial Port Clock Frequency	f <sub>SCLK</sub>			1	MHz	Active drive, 50% duty cycle
Distance from lens reference plane to surface	Z	2.18	2.40	2.62	mm	Results in +/- 0.22 mm minimum DOF. See Figure 8.
Speed	S			30	in/sec	
Acceleration	A			8	G	
Load Capacitance	C <sub>out</sub>			100	pF	MOTION, MISO

## **VCSEL's Optical/Electrical Characteristics**

Parameter	Symbol	Minimum	Typical	Maximum	Units	
Peak Wavelength	λ	832		865	nm	
Maximum Radiant Power	LOP <sub>max</sub>		4.5		mW	Maximum output power under any condition.  However, this is not a recommended operating condition and does not meet eye safety requirements
Threshold Current	I <sub>th</sub>		4.2		mA	
Forward Voltage	V <sub>F</sub>		1.9		V	At 500uW output power

### Comments:

- 1. VCSELs are sorted into bins as specified in the power adjustment procedure. Appropriate binning register data values are used in the application circuit to achieve the target output power. The VCSEL binning is marked on the integrated molded lead-frame DIP sensor package.
- 2. When driven with current or temperature range greater than specified in the power adjustment procedure section, eye safety limits may be exceeded. The VCSEL should then be treated as a Class IIIb laser and as a potential eye hazard.

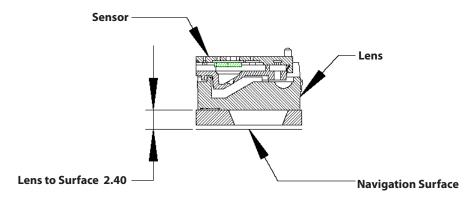


Figure 8. Distance from lens reference plane to surface, Z

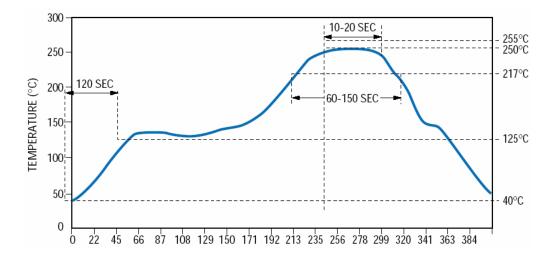


Figure 9. Recommended Soldering Reflow Profile

# **DC Electrical Specifications**

Electrical Characteristics over recommended operating conditions. (Typical values at 25 °C,  $V_{DD}$ =5.0 V,  $V_{DDIO}$ = 2.8V)

Parameter	Symbol	Minimum	Typical	Maximum	Units	Notes
DC Supply Current in various modes	I <sub>DD_RUN</sub>		2.8	3.5	mA	Average current, including LASER current. No load on MISO, MOTION.
Peak Supply Current				40	mA	
Shutdown Supply Current	I <sub>DDSTDWN</sub>		150	200	μΑ	NCS, SCLK = $V_{DDIO}$ MOSI, MISO = Hi-Z
Input Low Voltage	V <sub>IL</sub>			0.2V <sub>DDIO</sub>	V	SCLK, MOSI, NCS
Input High Voltage	V <sub>IH</sub>	0.8V <sub>DDIO</sub>			V	SCLK, MOSI, NCS
Input Hysteresis	V <sub>I_HYS</sub>		100		mV	SCLK, MOSI, NCS
Input Leakage Current	l <sub>leak</sub>		±1	±10	μA	Vin = 0.7*VDDIO , SCLK, MOSI, NCS
XY_LASER Current	I <sub>LAS</sub>		0.8		mA	$V_{XY\_LASER} >= 0.3V$ LSRPWR_CFG0 = 0xFF LSRPWR_CFG 1 = 0x00
Laser Current (fault mode)	I <sub>LAS_FAULT</sub>			300	uA	$XY\_LASER R_{leakage} < 75kOhms to Gnd$
Output Low Voltage, MISO, MOTION	$V_{0L}$			0.2*V <sub>DDIO</sub>	V	lout=1mA, MISO, MOTION
Output High Voltage, MISO, MOTION	V <sub>OH</sub>	0.8*V <sub>DDIO</sub>			V	lout=-1mA, MISO, MOTION
Output Low Voltage, LASER_NEN	V <sub>OL</sub>			0.2*V <sub>REFB</sub>	٧	lout= 1mA, LASER_NEN
Output High Voltage, LASER_NEN	V <sub>OH</sub>	0.8*V <sub>REFB</sub>			V	lout= -0.5mA, LASER_NEN
Input Capacitance	C <sub>in</sub>			10	pF	MOSI, NCS, SCLK

# **AC Electrical Specifications**

Electrical Characteristics over recommended operating conditions. (Typical values at 25 °C, VDD=5.0V, VDDIO= 2.8V)

Parameter	Symbol	Minimum	Typical	Maximum	Units	Notes
Motion delay after reset	t <sub>MOT-RST</sub>			23	ms	From SW_RESET register write to valid motion, assuming motion is present
Shutdown	t <sub>STDWN</sub>			50	ms	From Shutdown mode active to low current
Wake from shutdown	t <sub>WAKEUP</sub>	23			ms	From Shutdown mode inactive to valid motion. Notes: A RESET must be asserted after a shutdown. Refer to section "Notes on Shutdown and Forced Rest", also note tMOT-RST
Forced Rest enable	t <sub>REST-EN</sub>			1	S	From RESTEN bits set to low current
Wake from Forced Rest	t <sub>REST-DIS</sub>			1	S	From RESTEN bits cleared to valid motion
MISO rise time	t <sub>r-MISO</sub>		150	300	ns	C <sub>L</sub> = 100pF
MISO fall time	t <sub>f-MISO</sub>		150	300	ns	C <sub>L</sub> = 100pF
MISO delay after SCLK	t <sub>DLY-MISO</sub>			120	ns	From SCLK falling edge to MISO data valid, no load conditions
MISO hold time	t <sub>hold-MISO</sub>	0.5		1/f <sub>SCLK</sub>	us	Data held until next falling SCLK edge
MOSI hold time	t <sub>hold-MOSI</sub>	200			ns	Amount of time data is valid after SCLK rising edge
MOSI setup time	t <sub>setup-MOSI</sub>	120			ns	From data valid to SCLK rising edge
SPI time between write commands	t <sub>SWW</sub>	30			μς	From rising SCLK for last bit of the first data byte, to rising SCLK for last bit of the second data byte.
SPI time between write and read commands	t <sub>SWR</sub>	20			μs	From rising SCLK for last bit of the first data byte, to rising SCLK for last bit of the second address byte.
SPI time between read and subsequen commands	t t <sub>SRW</sub> t <sub>SRR</sub>	500			ns	From rising SCLK for last bit of the first data byte, to falling SCLK for the first bit of the address byte of the next command.
SPI read address-data delay	t <sub>SRAD</sub>	4			μς	From rising SCLK for last bit of the address byte, to falling SCLK for first bit of data being read.
NCS inactive after motion burst	t <sub>BEXIT</sub>	500			ns	Minimum NCS inactive time after motion burst before next SPI usage
NCS to SCLK active	t <sub>NCS-SCLK</sub>	120			ns	From NCS falling edge to first SCLK rising edge
SCLK to NCS inactive (for read operation)	t <sub>SCLK-NCS</sub>	120			ns	From last SCLK rising edge to NCS rising edge, for valid MISO data transfer
SCLK to NCS inactive (for write operation)	t <sub>SCLK-NCS</sub>	20			us	From last SCLK rising edge to NCS rising edge, for valid MOSI data transfer
NCS to MISO high-Z	t <sub>NCS-MISO</sub>			500	ns	From NCS rising edge to MISO high-Z state
MOTION rise time	t <sub>r-MOTION</sub>		150	300	ns	C <sub>L</sub> = 100pF
MOTION fall time	t <sub>f-MOTION</sub>		150	300	ns	C <sub>L</sub> = 100pF
Transient Supply Current	I <sub>DDT</sub>			45	mA	Max supply current during a VDD ramp from 0 to 2.8V

## Resolution vs Z- Height on General Surfaces (A7550)

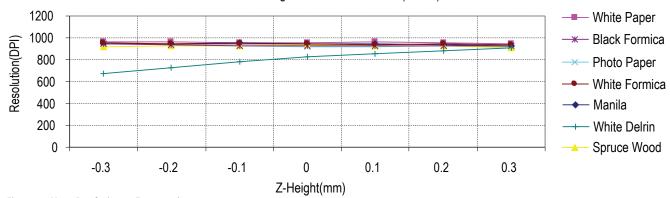


Figure 10. Mean Resolution vs. Z at 800cpi

Typical Path Deviation Largest Single Perpendicular Deviation From A Straight Line at 45 Degrees Path Length = 4 inches; Speed = 6 ips; Resolution = 800cpi

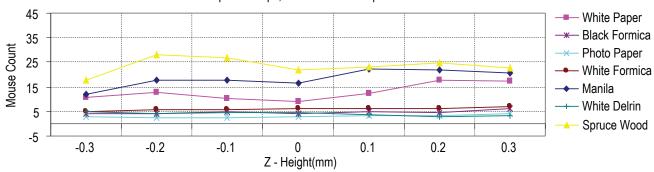


Figure 11. Average Error vs. Distance at 800cpi (mm)

## **VCSEL's Typical Characteristics**

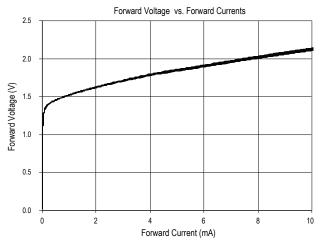


Figure 12. Forward Voltage vs. Forward Current for VCSEL

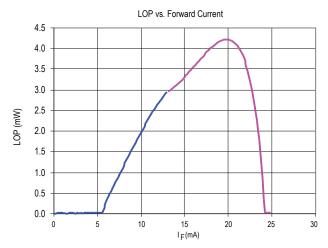


Figure 13. Optical Power vs. Forward Current for VCSEL

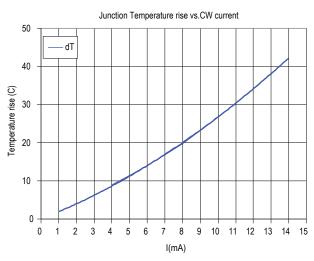


Figure 14. Junction Temperature Rise vs. Forward Current for VCSEL

## **Motion Pin Timing**

The motion pin is a level-sensitive output that signals the micro-controller when motion has occurred. The motion pin is lowered whenever the motion bit is set; in other words, whenever there is data in the Delta\_X or Delta\_Y registers. Clearing the motion bit (by reading Delta\_X and Delta\_Y, or writing to the Motion register) will put the motion pin high.

## **LASER Mode**

For power savings, the VCSEL will not be continuously on. ADNS-7550 will flash the VCSEL only when needed.

## **Synchronous Serial Port**

The synchronous serial port is used to set and read parameters in the ADNS-7550, and to read out the motion information. The port is a four-wire port. The host microcontroller always initiates communication; the ADNS-7550 never initiates data transfers. SCLK, MOSI, and NCS may be driven directly by a micro-controller. The port pins may be shared with other SPI slave devices. When the NCS pin is high, the inputs are ignored and the output is tri-stated.

The lines that comprise the SPI port:

SCLK: Clock input. It is always generated by the

master (the micro-controller).

MOSI: Input data. (Master Out/Slave In)

MISO: Output data. (Master In/Slave Out)

NCS: Chip select input (active low). NCS needs to be low to activate the serial port; otherwise, MISO will be high Z, and MOSI & SCLK will be ignored. NCS can also be used to reset the

serial port in case of an error.

## **Chip Select Operation**

The serial port is activated after NCS goes low. If NCS is raised during a transaction, the entire transaction is aborted and the serial port will be reset. This is true for all transactions. After a transaction is aborted, the normal address-to-data or transaction-to-transaction delay is still required before beginning the next transaction. To improve communication reliability, all serial transactions should be framed by NCS. In other words, the port should not remain enabled during periods of non-use because ESD and EFT/B events could be interpreted as serial communication and put the chip into an unknown state. In addition, NCS must be raised after each burst-mode transaction is complete to terminate burst-mode. The port is not available for further use until burst-mode is terminated.

## Write Operation

Write operation, defined as data going from the microcontroller to the ADNS-7550, is always initiated by the micro-controller and consists of two bytes. The first byte contains the address (seven bits) and has a "1" as its MSB to indicate data direction. The second byte contains the data. The ADNS-7550 reads MOSI on rising edges of SCLK.

## **Read Operation**

A read operation, defined as data going from the ADNS-7550 to the micro-controller, is always initiated by the micro-controller and consists of two bytes. The first byte contains the address, is sent by the micro-controller over MOSI, and has a "0" as its MSB to indicate data direction. The second byte contains the data and is driven by the ADNS-7550 over MISO. The sensor outputs MISO bits on falling edges of SCLK and samples MOSI bits on every rising edge of SCLK.

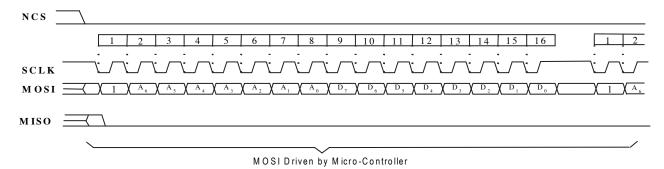


Figure 15. Write Operation

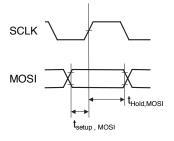


Fig ure 16. MOSI Setup and Hold Time

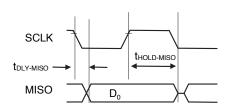
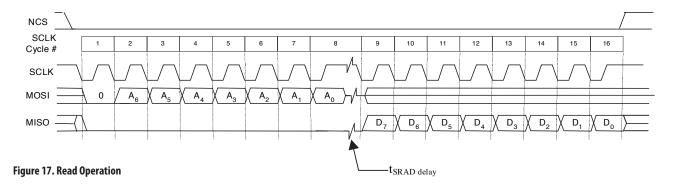


Figure 18. MISO Delay and Hold Time



## Note:

The 0.5/fSCLK minimums high state of SCLK is also the minimum MISO data hold time of the ADNS-7550. Since the falling edge of SCLK is actually the start of the next read or write command, the ADNS-7550 will hold the state of data on MISO until the falling edge of SCLK.

## Required timing between Read and Write Commands

There are minimum timing requirements between read and write commands on the serial port.

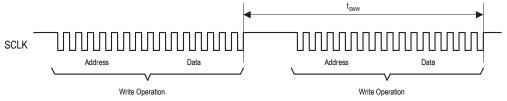


Figure 19. Timing between two write commands

If the rising edge of the SCLK for the last data bit of the second write command occurs before the required delay (t<sub>SWW</sub>), then the first write command may not complete correctly.

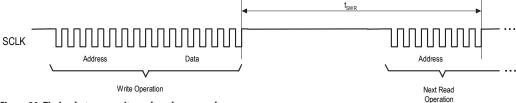


Figure 20. Timing between write and read commands

If the rising edge of SCLK for the last address bit of the read command occurs before the required delay (t<sub>SWR</sub>), the write command may not complete correctly.

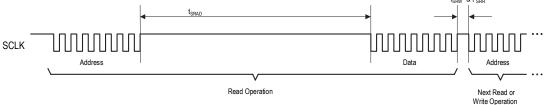


Figure 21. Timing between read and either write or subsequent read commands

During a read operation SCLK should be delayed at least  $t_{SRAD}$  after the last address data bit to ensure that the ADNS-7550 has time to prepare the requested data. The falling edge of SCLK for the first address bit of either the read or write command must be at least  $t_{SRR}$  or  $t_{SRW}$  after the last SCLK rising edge of the last data bit of the previous read operation.

## **Burst Mode Operation**

Burst mode is a special serial port operation mode that may be used to reduce the serial transaction time for a motion read. The speed improvement is achieved by continuous data clocking to or from multiple registers without the need to specify the register address, and by not requiring the normal delay period between data bytes.

Burst mode is activated by reading the Motion\_Burst register. The ADNS-7550 will respond with the contents of the Motion, Delta\_X\_L, Delta\_X\_L, Delta\_XY\_H, SQUAL, Shutter\_Upper, Shutter\_Lower and Maximum\_Pixel registers in that order. The burst transaction can be terminated anywhere in the sequence after the Delta\_X value by bringing the NCS pin high. After sending the register address, the micro-controller must wait tsrad and then begin reading data. All data bits can be read with no delay between bytes by driving SCLK at the normal rate. The data are latched into the output buffer after the last address bit is received. After the burst transmission is complete, the micro-controller must raise the NCS line for at least tbright to terminate burst mode. The serial port is not available for use until it is reset with NCS, even for a second burst transmission.

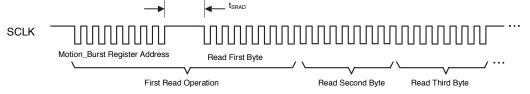


Figure 22. Motion Burst Timing

## **Notes on Power-up**

The ADNS-7550 does not perform an internal power up self-reset; the POWER\_UP\_RESET register must be written every time power is applied. The appropriate sequence is as follows:

- i. Apply power
- ii. Drive NCS high, then low to reset the SPI port.
- iii. Write 0x5a to register 0x3a.
- iv. Wait for at least one frame.
- v. Clear observation register.
- vi. Wait at least one frame and check observation register, all bits 0-3 must be set.
- vii. Read from registers 0x02, 0x03, 0x04 and 0x05 (or read these same 4 bytes from burst motion register 0x42) one time regardless of the motion pin state.
- viii. Write 0x27 to register 0x3C
- ix. Write 0x0a to register 0x22
- x. Write 0x01 to register 0x21
- xi. Write 0x32 to register 0x3C
- xii. Write 0x20 to register 0x23
- xiii. Write 0x05 to register 0x3C

During power-up there will be a period of time after the power supply is high but before any clocks are available. The table below shows the state of the various pins during power-up and reset.

## State of Signal Pins After VDD is Valid

	0n	Befor		
Pin	Power-Up	NCS High	NCS Low	After Reset
NCS	Functional	Hi	Low	Functional
MISO	Undefined	Undefined	Functional	Depends on NCS
SCLK	Ignored	Ignored	Functional	Depends on NCS
MOSI	Ignored	Ignored	Functional	Depends on NCS
MOTION	Undefined	Undefined	Undefined	Functional
LASER_NEN	Undefined	Undefined	Undefined	Functional

## Notes on Shutdown

The ADNS-7550 can be set in Shutdown mode by writing 0xe7 to register 0x3b. The SPI port should not be accessed when Shutdown mode is asserted, except the power-up command (writing 0x5a to register 0x3a). (Other ICs on the same SPI bus can be accessed, as long as the sensor's NCS pin is not asserted.) The table below shows the state of various pins during shutdown. To deassert Shutdown mode:

- i. Write 0x5a to register 0x3a
- ii. Wait for at least one frame.
- iii. Clear observation register.
- iv. Wait at least one frame
- v. Check observation register, all bits 0-3 must be set to
   1.
- vi. Write 0x27 to register 0x3C
- vii. Write 0x0a to register 0x22
- viii. Write 0x01 to register 0x21
- ix. Write 0x32 to register 0x3C
- x. Write 0x20 to register 0x23
- xi. Write 0x05 to register 0x3C
- xii. Any register settings must then be reloaded.

Pin	Status when Shutdown Mode
NCS	Functional <sup>[1]</sup>
MISO	Undefined [2]
SCLK	Ignore if NCS = 1 [3]
MOSI	Ignore if NCS = 1 [4]
LASER_NEN	High(off)
MOTION	Undefined [2]

- 1. NCS pin must be held to 1 (high) if SPI bus is shared with other devices. It is recommended to hold to 1 (high) during Power Down unless powering up the Sensor. It must be held to 0 (low) if the sensor is to be re-powered up from shutdown (writing 0x5a to register 0x3a).
- 2. Depend on last state
- 3. SCLK is ignore if NCS is 1 (high). It is functional if NCS is 0 (low).
- 4. MOSI is ignore if NCS is 1 (high). If NCS is 0 (low), any command present on the MOSI pin will be ignored except power-up command (writing 0x5a to register 0x3a).

#### Note:

There are long wakeup times from shutdown and forced Rest. These features should not be used for power management during normal mouse motion.

# Registers

The ADNS-7550 registers are accessible via the serial port. The registers are used to read motion data and status as well as to set the device configuration.

Address	Register	Read/Write	Default Value
0x00	Product_ID	R	0x32
0x01	Revision_ID	R	0x03
0x02	Motion	R/W	0x00
0x03	Delta_X_L	R	0x00
0x04	Delta_Y_L	R	0x00
0x05	Delta_XY_H	R	0x00
0x06	SQUAL	R	0x00
0x07	Shutter_Upper	R	0x00
0x08	Shutter_Lower	R	0x64
0x09	Maximum_Pixel	R	0xd0
0x0a	Pixel_Sum	R	0x80
0x0b	Minimum_Pixel	R	0x00
0x0c	CRCO	R	0x00
0x0d	CRC1	R	0x00
0x0e	CRC2	R	0x00
0x0f	CRC3	R	0x00
0x10	Self_Test	W	NA
0x11	Reserved		
0x12	Configuration2_Bits	R/W	0x28
0x13-0x19	Reserved		
0x1a	LASER_CTRLO	R/W	0x00
0x1b	Reserved		
0x1c	LSRPWR_CFG0	R/W	0x00
0x1d	LSRPWR_CFG1	R/W	0x00
0x1e	Reserved		
0x1f	LASER_CTRL1	R/W	0x00
0x20-0x2d	Reserved		
0x2e	Observation	R/W	0x00
0x2f-0x34	Reserved		
0x35	Pixel_Grab	R/W	0x00
0x36-0x39	Reserved		
0x3a	POWER_UP_RESET	W	NA
0x3b	Shutdown	W	NA
0x3c	Reserved		
0x3d	Shut_thr	R/W	0x56
0x3e	Inverse_Revision_ID	R	0xfc
0x3f	Inverse_Product_ID	R	0xcd
0x42	Motion_Burst	R	0x00

Product_ID	Address:	Address: 0x00						
Access: Read Reset Value: 0x32								
Bit	7	6	5	4	3	2	1	0
Field	PID <sub>7</sub>	PID <sub>6</sub>	PID <sub>5</sub>	PID <sub>4</sub>	PID <sub>3</sub>	PID <sub>2</sub>	PID <sub>1</sub>	PID <sub>0</sub>

Data Type: 8-Bit unsigned integer

USAGE: This register contains a unique identification assigned to the ADNS-7550. The value in this register does not change; it can be used to verify that the serial communications link is functional.

F	Revision_ID			Address:	0x01				
A	Access: Read			Reset Va	lue: 0x03				
	Bit	7	6	5	4	3	2	1	0
	Field	RID <sub>7</sub>	RID <sub>6</sub>	RID <sub>5</sub>	RID <sub>4</sub>	RID <sub>3</sub>	RID <sub>2</sub>	RID <sub>1</sub>	RID <sub>0</sub>

Data Type: 8-Bit unsigned integer.

USAGE: This register contains the IC revision. It is subject to change when new IC versions are released.

Motion			Addres	ss: 0x02						
Access: Re	ad/Write		Reset '	Reset Value: 0x00						
Bit	7	6	5	4	3	2	1	0		
Field	MOT	PIXRDY	PIXFIRST	OVF	LP_VALID	FAULT	Reserved	Reserved		

Data Type: Bit field.

USAGE: Register 0x02 allows the user to determine if motion has occurred since the last time it was read. If the MOT bit is set, then the user should read registers 0x03 and 0x04 to get the accumulated motion. Read this register before reading the Delta\_X\_L, Delta\_Y\_L and Delta\_XY\_H registers.

Writing anything to this register clears the MOT and OVF bits, Delta\_X\_L, Delta\_Y\_L and Delta\_XY\_H registers. The written data byte is not saved.

If one of the 12 bits motion registers overflows, then absolute path data is lost and the OVF bit is set. Once OVF bit set, Sensor will stop accumulating motion data. Motion registers and OVF bit will be clear after data been read out.

The PIXRDY bit will be set whenever a valid pixel data byte is available in the Pixel\_Dump register. Check that this bit is set before reading from Pixel\_Dump. To ensure that the Pixel\_Grab pointer has been reset to pixel 0,0 on the initial write to Pixel\_Grab, check to see if PIXFIRST is set to high.

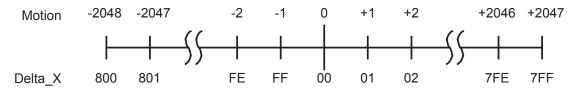
Field Name	Description
MOT	Motion since last report  0 = No motion  1 = Motion occurred, data ready for reading in Delta_X_L, Delta_Y_L and Delta_XY_H registers
PIXRDY	Pixel Dump data byte is available in Pixel_Dump register  0 = data not available  1 = data available
PIXFIRST	This bit is set when the Pixel_Grab register is written to or when a complete pixel array has been read, initiating an increment to pixel 0,0.  0 = Pixel_Grab data not from pixel 0,0  1 = Pixel_Grab data is from pixel 0,0
OVF	Motion overflow, $\Delta Y$ and/or $\Delta X$ buffer has overflowed since last report $0=$ no overflow $1=$ Overflow has occurred
LP_VALID	Laser Power Settings $0 = \text{register } 0 \times 16$ and register $0 \times 16$ do not have complementary values $1 = \text{laser } power$ is valid
FAULT	Indicates that VCSEL is shorted to GND or VDD  0 = no fault detected  1 = fault detected.

Note: Avago recommends that registers 0x02, 0x03, 0x04and 0x05 be read sequentially.

#### Delta\_X\_L Address: 0x03 Access: Read Reset Value: 0x00 7 Bit 6 5 4 3 2 1 0 Field $X_7$ $X_6$ $X_5$ $X_4$ $\chi_3$ $X_2$ $X_1$ $X_0$

Data Type: Eight bit 2's complement number.

USAGE: X movement is counts since last report. Absolute value is determined by resolution. Reading clears the register.

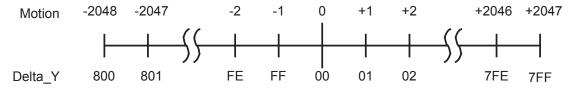


NOTE: Avago recommends that registers 0x02, 0x03, 0x04 and 0x05 be read sequentially.

Delta_Y_L Address: 0x04								
Access: Re	ad		Reset \	/alue: 0x00				
Bit	7	6	5	4	3	2	1	0
Field	Y <sub>7</sub>	Y <sub>6</sub>	Y <sub>5</sub>	Y <sub>4</sub>	Y <sub>3</sub>	Y <sub>2</sub>	Y <sub>1</sub>	Y <sub>0</sub>

Data Type: Eight bit 2's complement number.

USAGE: Y movement is counts since last report. Absolute value is determined by resolution. Reading clears the register.



NOTE: Avago recommends that registers 0x02, 0x03, 0x04 and 0x05 be read sequentially.

Delta_XY_	Н		Addres	s: 0x05						
Access: Re	Access: Read			Reset Value: 0x00						
Bit	7	6	5	4	3	2	1	0		
Field	X <sub>11</sub>	X <sub>10</sub>	X <sub>9</sub>	X <sub>8</sub>	X <sub>11</sub>	X <sub>10</sub>	X <sub>9</sub>	X <sub>8</sub>		

Data Type: 2's complement number, upper 4 bits of Delta\_X and Delta\_Y.

USAGE: Delta\_XY\_H must be read after Delta\_X\_L and Delta\_Y\_L to have the full motion data. Reading clear the registers.

NOTE: Avago recommends that registers 0x02, 0x03, 0x04 and 0x05 be read sequentially.

SQUAL			Addre	ss: 0x06						
Access: Re	ad		Reset	Reset Value: 0x00						
Bit	7	6	5	4	3	2	1	0		
Field	SQ <sub>7</sub>	SQ <sub>6</sub>	SQ <sub>5</sub>	SQ <sub>4</sub>	SQ <sub>3</sub>	SQ <sub>2</sub>	SQ <sub>1</sub>	SQ <sub>0</sub>		

Data Type: Upper 8 bits of a 9-bit unsigned integer.

USAGE: SQUAL (Surface Quality) is a measure of the number of valid features visible by the sensor in the current frame.

The maximum SQUAL register value is 242. Since small changes in the current frame can result in changes in SQUAL, variations in SQUAL when looking at a surface are expected. The graph below shows 800 sequentially acquired SQUAL values, while a sensor was moved slowly over white paper. SQUAL is nearly equal to zero, if there is no surface below the sensor. SQUAL is typically maximized when the navigation surface is at the optimum distance from the imaging lens (the nominal Z-height).

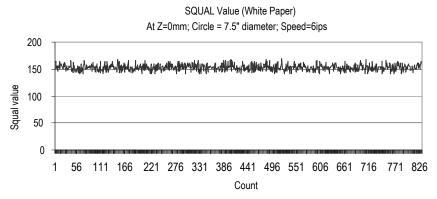


Figure 23. SQUAL Values at 800cpi (White Paper)

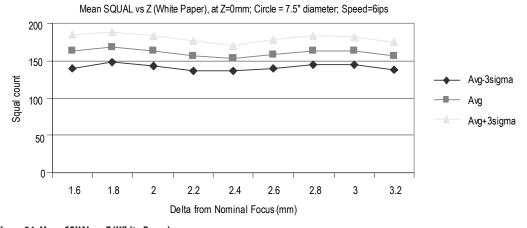


Figure 24. Mean SQUAL vs. Z (White Paper)

Shutter_U	pper		Addre	ss: 0x07						
Access: Re	ad		Reset '	Reset Value: 0x00						
Bit	7	6	5	4	3	2	1	0		
Field	S <sub>15</sub>	S <sub>14</sub>	S <sub>13</sub>	S <sub>12</sub>	S <sub>11</sub>	S <sub>10</sub>	S <sub>9</sub>	S <sub>8</sub>		
Shutter_L	ower		Addre	ss: 0x08						
Access: Re	ead		Reset	Value: 0x64						
Bit	7	6	5	4	3	2	1	0		
Field	S <sub>7</sub>	S <sub>6</sub>	S <sub>5</sub>	S <sub>4</sub>	S <sub>3</sub>	S <sub>2</sub>	S <sub>1</sub>	S <sub>0</sub>		

Data Type: Sixteen bit unsigned integer.

USAGE: Units are clock cycles. Read Shutter\_Upper first, then Shutter\_Lower. They should be read consecutively. The shutter is adjusted to keep the average and maximum pixel values within normal operating ranges. The shutter value is automatically adjusted.

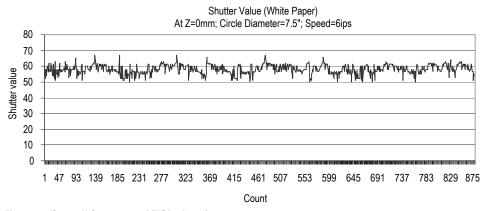


Figure 25. Shutter Values at 800cpi (White Paper)

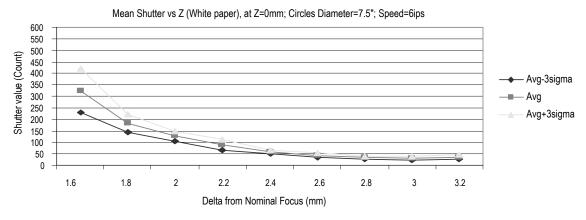


Figure 26. Mean Shutter vs. Z (White Paper)

Maximum_Pixel			Addres	ss: 0x09						
Access: Re	ad		Reset '	Reset Value: 0xd0						
Bit	7	6	5	4	3	2	1	0		
Field	MP <sub>7</sub>	MP <sub>6</sub>	MP <sub>5</sub>	MP <sub>4</sub>	MP <sub>3</sub>	MP <sub>2</sub>	MP <sub>1</sub>	MP <sub>0</sub>		

Data Type: Eight-bit number.

USAGE: Maximum Pixel value in current frame. Minimum value = 0, maximum value = 254. The maximum pixel value can vary with every frame.

Pixel_Sum				ss: 0x0a						
Access: Rea	ad		Reset '	Reset Value: 0x80						
Bit	Bit 7 6			4	3	2	1	0		
Field	AP <sub>7</sub>	AP <sub>6</sub>	AP <sub>5</sub>	AP <sub>4</sub>	AP <sub>3</sub>	AP <sub>2</sub>	AP <sub>1</sub>	AP <sub>0</sub>		

Data Type: High 8 bits of an unsigned 16-bit integer.

USAGE: This register is used to find the average pixel value. It reports the upper eight bits of a 18-bit counter, which sums all pixels in the current frame. It may be described as the full sum divided by 1024. To find the average pixel value, use the following formula:

Average Pixel = Register Value \* 1024/676 = Register Value \* 1.515

The maximum register value is 167. The minimum is 0. The pixel sum value can change on every frame.

Minimum_	Pixel		Addres	Address: 0x0b							
Access: Rea	ad		Reset '	Reset Value: 0x00							
Bit	7	6	5	4	3	2	1	0			
Field	MP <sub>7</sub>	MP <sub>6</sub>	MP <sub>5</sub>	MP <sub>4</sub>	MP <sub>3</sub>	MP <sub>2</sub>	MP <sub>1</sub>	MP <sub>0</sub>			

Data Type: Eight-bit number.

USAGE:Minimum Pixel value in current frame. Minimum value = 0, maximum value = 254. The minimum pixel value can vary with every frame.

CRCO			ldress: 0x0c						
Access: Read			Reset Value: 0x00						
Bit	7	6	5	4	3	2	1	0	
Field	CRC0 <sub>7</sub>	CRC0 <sub>6</sub>	CRC0 <sub>5</sub>	CRC0 <sub>4</sub>	CRC0 <sub>3</sub>	CRC0 <sub>2</sub>	CRC0 <sub>1</sub>	CRC0 <sub>0</sub>	

Data Type: Eight-bit number.

USAGE: Register 0x0c reports the first byte of the system self test results. Value = TBD.

CRC1		Ac	ldress: 0x0d					
Access: Read			eset Value: 0x	00				
Bit	Bit 7 6			4	3	2	1	0
Field	CRC1 <sub>7</sub>	CRC1 <sub>6</sub>	CRC1 <sub>5</sub>	CRC1 <sub>4</sub>	CRC1 <sub>3</sub>	CRC1 <sub>2</sub>	CRC1 <sub>1</sub>	CRC1 <sub>0</sub>

Data Type: Eight-bit number.

USAGE: Register 0x0d reports the first byte of the system self test results. Value = TBD.

CRC2		Ac	Address: 0x0e							
Access: Read Reset Value: 0x00										
Bit	7	6	5	4	3	2	1	0		
Field	CRC2 <sub>7</sub>	CRC2 <sub>6</sub>	CRC2 <sub>5</sub>	CRC2 <sub>4</sub>	CRC2 <sub>3</sub>	CRC2 <sub>2</sub>	CRC2 <sub>1</sub>	CRC2 <sub>0</sub>		

Data Type: Eight-bit number.

USAGE: Register 0x0e reports the first byte of the system self test results. Value = TBD.

CRC3			Address: 0x0f						
Access: Re	ad	Re	Reset Value: 0x00						
Bit	7	6	5	4	3	2	1	0	
Field	CRC3 <sub>7</sub>	CRC3 <sub>6</sub>	CRC3 <sub>5</sub>	CRC3 <sub>4</sub>	CRC3 <sub>3</sub>	CRC3 <sub>2</sub>	CRC3 <sub>1</sub>	CRC3 <sub>0</sub>	

Data Type: Eight-bit number.

USAGE: Register 0x0f reports the first byte of the system self test results. Value = TBD.

Self_Test			Address: 0x10						
Access: Write			Reset Value: NA						
Bit	7	6	5	4	3	2	1	0	
Field	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved	TESTEN	

Data Type: Bit field

USAGE: Set the TESTEN bit in register 0x10 to start the system self-test. The test takes 250ms. During this time, do not write or read through the SPI port. Results are available in the CRC0-3 registers. After self-test, reset the chip to start normal operation.

Field Name	Description			
TESTEN	Enable System Self Test			
	0 = Disabled			
	1 = Enable			

Reserved Address: 0x11

Configuration2_bits			Address: 0x12						
Access: Read/Write Reset Value: 0x28									
Bit	7	6	5	4	3	2	1	0	
Field	0	RES <sub>1</sub>	RES <sub>0</sub>	Reserved	Reserved	Reserved	Reserved	TESTEN	

Data Type: Bit field

USAGE: Register 0x12 allows the user to change the configuration of the sensor. The RES bit allows selection between 400, 800, 1200 and 1600 cpi resolution.

Field Name	Description
RES[1:0]	Sets resolution
	00 = 400
	01 = 800
	10 = 1200
	11 = 1600

Reserved Address: 0x1b

#### LASER\_CTRLO Address: 0x1a Access: Read/Write Reset Value: 0x00 6 5 4 3 2 0 Bit 7 1 Field Range0 Reserved Reserved $CAL_2$ $CAL_1$ $CAL_0$ Force\_Disable Range1

Data Type: Bit field

USAGE: This register is used to control the laser drive. Bits 7 and 6 require complement values in register 0x1F. If the registers do not contain complementary values for these bits, the laser is turned off and the LP\_VALID bit in the MOTION register is set to 0. The registers may be written in any order after the power ON reset.

Field Name	Description
Range[1:0]	Rbin Settings
	00= Laser current range from approximately 0.9mA to 3mA
	01= Laser current range from approximately 2mA to 5mA
	11 = Laser current range from approximately 4mA to 10mA
	10 = Invalid setting, LPVALID will be set and laser will off.
CAL <sub>2-0</sub>	Laser calibration mode
	- Write 101b to bits [3,2,1] to set the laser to continuous ON (CW) mode.
	- Write 000b to exit laser calibration mode, all other values are not recommended.
	Reading the Motion register (0x02 or 0x42) will reset the value to 000b and exit calibration mode.
Force_Disable	LASER force disabled
	0 = LASER_NEN functions as normal
	1 = LASER_NEN output is high.

#### LSRPWR\_CFG0 Address: 0x1c Access: Read/Write Reset Value: 0x00 6 3 2 0 Bit 4 1 Field LP<sub>7</sub> $LP_6$ LP<sub>5</sub> $LP_4$ $LP_3$ $LP_2$ $LP_1$ $LP_0$

Data Type: 8 Bit unsigned

USAGE: This register is used to set the laser current. It is to be used together with register 0x1D, where register 0x1D contains the complement of register 0x1C. If the registers do not contain complementary values, the laser is turned off and the LP\_VALID bit in the MOTION register is set to 0. The registers may be written in any order after the power ON reset.

Field Name	Description
	Controls the 8-bit DAC for adjusting laser current.
	One step is equivalent to $(1/384)*100\% = 0.26\%$ drop of relative laser current.
LP7 – LP0	Refer to the table below for examples of relative laser current settings.

LP7 - LP3	LP 2	LP 1	LP 0	Relative Laser Current
00000	0	0	0	33.59%
00000	0	0	1	33.85%
00000	0	1	0	34.11%
::	:	:	:	::
11111	1	0	1	99.48%
11111	1	1	0	99.74%
11111	1	1	1	100%

LSRPWR_CFG1			Address: 0x1d						
Access: Read/Write Reset Value: 0x00									
Bit	7	6	5	4	3	2	1	0	
Field	LPC <sub>7</sub>	LPC <sub>6</sub>	LPC <sub>5</sub>	LPC <sub>4</sub>	LPC <sub>3</sub>	LPC <sub>2</sub>	LPC <sub>1</sub>	LPC <sub>0</sub>	

Data Type: 8 Bit unsigned

USAGE: The value in this register must be a complement of register 0x1C for laser current to be as programmed, otherwise the laser is turned off and the LP\_VALID bit in the MOTION register is set to 0. Registers 0x1C and 0x1D may be written in any order after power ON reset.

Reserved Address: 0x1e

#### LASER\_CTRL1 Address: 0x1f Access: Read/Write Reset Value: 0x00 Bit 6 5 4 3 2 1 0 Field Range\_C1 Range\_C0 Reserved Reserved Reserved Reserved Reserved Reserved

Data Type: 8 Bit unsigned

USAGE: Bits 7 and 6 of this register must be the complement of the corresponding bits in register 0x1A for the VCSEL control to be as programmed, otherwise the laser turned is off and the LP\_VALID bit in the MOTION register is set to 0. Registers 0x1A and 0x1F may be written in any order after power ON reset.

Reserved Address: 0x20-0x2	2d
----------------------------	----

Observation			Address: 0x2e						
Access: Read/Write Reset Value: 0x00									
Bit	7	6	5	4	3	2	1	0	
Field	MODE <sub>1</sub>	MODE <sub>0</sub>	Reserved	OBS <sub>4</sub>	OBS <sub>3</sub>	OBS <sub>2</sub>	OBS <sub>1</sub>	OBS <sub>0</sub>	

Data Type: Bit field

USAGE: Register 0x2e provides bits that are set every frame. It can be used during EFT/B testing to check that the chip is running correctly. Writing anything to this register will clear the bits. Wait for at least one frame before reading the register.

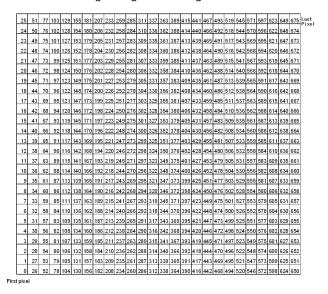
Field Name	Description
MODE <sub>1-0</sub>	Mode Status: Reports which mode the sensor is in. $00 = Run$
	01 = Rest 1
	10 = Rest 2 11 = Rest 3
OBS <sub>4-0</sub>	Set every frame

Reserved Address: 0x2f-0x34, 0x36-0x39

Pixel_Grab			Ac	Address: 0x35						
Access: Read/Write			Re	Reset Value: 0x00						
	Bit	7	6	5	4	3	2	1	0	
	Field	PD <sub>7</sub>	PD <sub>6</sub>	PD <sub>5</sub>	PD <sub>4</sub>	PD <sub>3</sub>	PD <sub>2</sub>	PD <sub>1</sub>	PD <sub>0</sub>	

Data Type: 8 Bit Word

USAGE: For test purposes, the sensor will read out the contents of the pixel array, one pixel per frame. To start a pixel grab, write anything to this register to reset the pointer to pixel 0,0. Then read the PIXRDY bit in the Motion register. When the PIXRDY bit is set, there is valid data in this register to read out. After the data in this register is read, the pointer will automatically increment to the next pixel. Reading may continue indefinitely; once a complete frame's worth of pixels has been read, PIXFIRST will be set to high to indicate the start of the first pixel and the address pointer will start at the beginning location again.



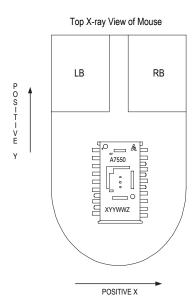


Figure 27. Pixel Address Map (sensor looking on the navigation surface through the lens)

POWER_UP_RESET		Ac	ldress: 0x3a					
Access:	Write	Reset Value	e: NA					
Bit	7	6	5	4	3	2	1	0
Field	RST <sub>7</sub>	RST <sub>6</sub>	RST <sub>5</sub>	RST <sub>4</sub>	RST <sub>3</sub>	RST <sub>2</sub>	RST <sub>1</sub>	RST <sub>0</sub>

Data Type: 8 Bit integer

USAGE: Write 0x5a to this register to reset the chip. All settings will revert to default values. Reset is required after recovering from shutdown mode.

SHUTDOWN			Address: 0x3b						
Access: Write Only			Reset Value: NA						
Bit	7	6	5	4	3	2	1	0	
Field	SD <sub>7</sub>	SD <sub>6</sub>	SD <sub>5</sub>	SD <sub>4</sub>	SD <sub>3</sub>	SD <sub>2</sub>	SD <sub>1</sub>	SD <sub>0</sub>	

Data Type: 8 Bit integer

USAGE: Write 0xe7 to set the chip to shutdown mode, use POWER\_UP\_RESET register (address 0x3b) to power up the chip.

Reserved		Ac	Address: 0x3c							
Shut_thr			Ac	Address: 0x3d						
Access: Read/Write			Re	eset Value: 0x	56					
	Bit	7	6	5	4	3	2	1	0	
	Field	Shut_thr <sub>7</sub>	Shut_thr <sub>6</sub>	Shut_thr <sub>5</sub>	Shut_thr <sub>4</sub>	Shut_thr <sub>3</sub>	Shut_thr <sub>2</sub>	Shut_thr <sub>1</sub>	Reserved	

Data Type: 7 Bit number

USAGE: Threshold defines the Shutter value when lifted runaway happens.

Sensor will suspect lifted runaway happens and suppress motion if the following condition happens, (Shutter >  $Shut_Thr[7:1] * 32dec$ ) AND (Saturated pixel >  $Satpix_thr * 2dec$ )

Inverse_Revision_ID			Address: 0x3e						
Access: Read			Reset Value: 0xfc						
Bit	7	6	5	4	3	2	1	0	
Field	NRID <sub>7</sub>	NRID <sub>6</sub>	NRID <sub>5</sub>	NRID <sub>4</sub>	NRID <sub>3</sub>	NRID <sub>2</sub>	NRID <sub>1</sub>	NRID <sub>0</sub>	

Data Type: Inverse 8-Bit unsigned integer

USAGE: This value is the inverse of the Revision\_ID. It can be used to test the SPI port.

Inverse_Product_ID			Ac	Address: 0x3f						
Access: Write Only				Reset Value: NA						
	Bit	7	6	5	4	3	2	1	0	
	Field	NPID <sub>7</sub>	NPID <sub>6</sub>	NPID <sub>5</sub>	NPID <sub>4</sub>	NPID <sub>3</sub>	NPID <sub>2</sub>	NPID <sub>1</sub>	NPID <sub>0</sub>	

Data Type: Inverse 8-Bit unsigned integer

USAGE: This value is the inverse of the Product\_ID. It can be used to test the SPI port.

Motion_B	urst	Ad	ldress: 0x42					
Access: Re	ad	Reset Value	e: 0x00					
Bit	7	6	5	4	3	2	1	0
Field	MB <sub>7</sub>	MB <sub>6</sub>	MB <sub>5</sub>	MB <sub>4</sub>	MB <sub>3</sub>	MB <sub>2</sub>	MB <sub>1</sub>	MB <sub>0</sub>

Data Type: Various

USAGE: Read from this register to activate burst mode. The sensor will return the data in the Motion register, Delta\_X\_L, Delta\_Y\_L, Delta\_XY\_H, Squal, Shutter\_Upper, Shutter\_Lower and Maximum\_Pixel. Reading the first 3 bytes clears the motion data. The read may be terminated anytime after Delta\_X is read.

